TOSHIBA PHOTOCOUPLER PHOTO RELAY

TLP3230

MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3230 is a super small-outline photorelay, suitable for surface-mount assembly. The TLP3230 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics also include low OFF-state current and low output pin capacitance, enabling it to be used in high-frequency measuring instruments.

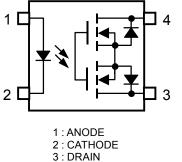
Features

- 4 pin SSOP (SSOP4)
- : 1.8 mm high, 1.27 mm pitch
- 1-Form-A
- Peak Off-State Voltage : 20 V (MIN.)
- Trigger LED Current : 4 mA (MAX.)
 - : 160 mA (MAX.)
 - : 8Ω(MAX.), 5Ω(TYP.)
- On-State ResistanceOutput Capacitance
- Isolation Voltage

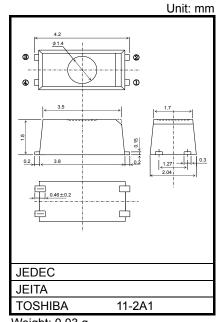
• On-State Current

- : 2.5 pF (MAX.), 1.0 pF (TYP.)
- : 1500 Vrms (MIN.)

Pin Configuration (top view)



4 : DRAIN



Weight: 0.03 g

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current	lF	50	mA
ED	Forward Current Derating (Ta $\ge 25^{\circ}$ C)	∆I _F /°C	-0.5	mA/°C
ш	Reverse Voltage	V _R	5	V
	Junction Temperature	Tj	125	°C
ъ	Off-State Output Terminal Voltage	V _{OFF}	20	V
CTO	On-State Current	I _{ON}	160	mA
DETECTOR	On-State Current Derating (Ta \ge 25°C)	∆l _{ON} /°C	-1.6	mA/°C
ā	Junction Temperature	Tj	125	°C
Storage Temperature Range		T _{stg}	-40~125	°C
Oper	ating Temperature Range	T _{opr}	-20~85	°C
Lead	Soldering Temperature (10 s)	T _{sol}	260	°C
Isolat	tion Voltage (AC, 1 minute, R.H. \leq 60%) (NOTE1)	BVS	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Caution

This device is sensitive to electrostatic discharge. When using this device, please ensure that all tools and equipment are earthed.

This device is applying super small package which is free for Moisture-Proof packing. However, the application of this device is premised on use under controlled environmental condition like as measuring instrument. It is necessary to take precautions of storage condition and operating environmental condition.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{DD}	_	_	20	V
Forward Current	١ _F	10		30	mA
On-State Current	I _{ON}			160	mA
Operating Temperature	T _{opr}	25		60	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Individual Electrical Characteristics (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V _F	$I_F = 10 \text{ mA}$	1.0	1.15	1.3	V
LED	Reverse Current	I _R	$V_R = 5 V$	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	15	_	pF
CTOR	Off-State Current	IOFF	V _{OFF} = 20 V, Ta = 50°C			1000	pА
DETEC.	Capacitance	C _{OFF}	V = 0, f = 100 MHz, t < 1 s	_	1.0	2.5	pF

⁽NOTE 1): Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

Coupled Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I _{FT}	I _{ON} = 100 mA	_	_	4	mA
Return LED Current	I _{FC}	I _{OFF} = 10 μA	0.2	0.75	_	mA
On-State Resistance	R _{ON}	I _{ON} = 160 mA, I _F = 5 mA, t < 1 s		5	8	Ω

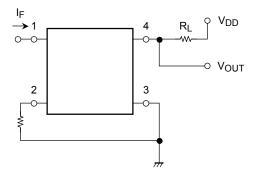
Isolation Characteristics (Ta = 25°C)

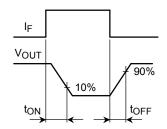
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	CS	$V_{S} = 0 V$, f = 1 MHz	_	0.3	_	pF
Isolation Resistance	R _S	$V_{S} = 500 \text{ V}, \text{ R.H.} \le 60\%$	$5 imes 10^{10}$	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	1500	_	_	Vrms
Isolation Voltage		AC, 1 second (in oil)	_	3000	_	VIIIS
		DC, 1 minute (in oil)	—	3000		Vdc

Switching Characteristics (Ta = 25°C)

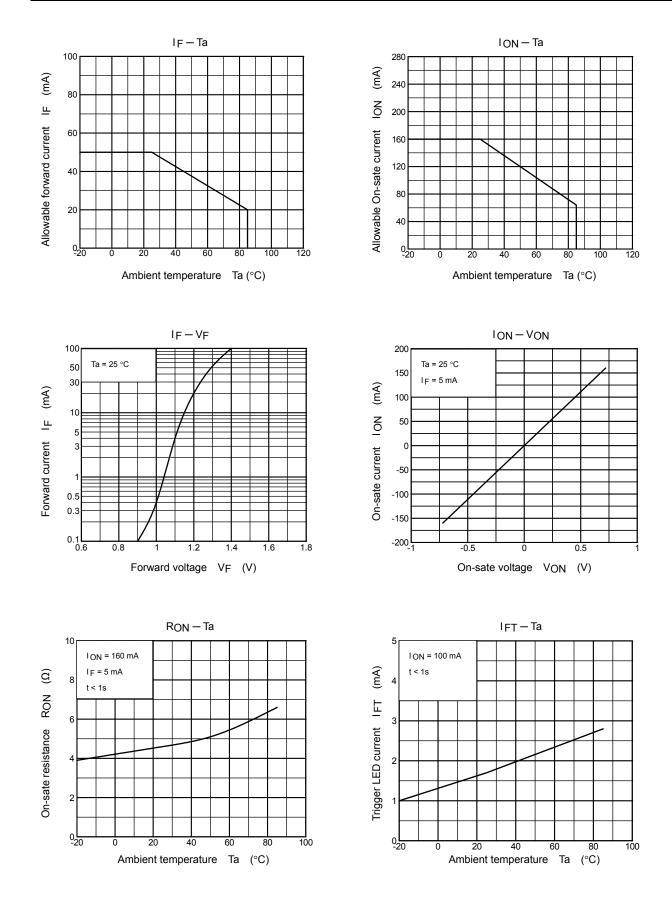
CHARACTERISTIC SYMBOL TEST CONDITION		MIN.	TYP.	MAX.	UNIT		
Turn-on Time	t _{ON}	R _L = 200 Ω (N	NOTE 4)	-	60	500	
Turn-off Time	tOFF	V _{DD} = 10 V, I _F = 5 mA		_	120	500	μS

(NOTE 4) : SWITCHING TIME TEST CIRCUIT

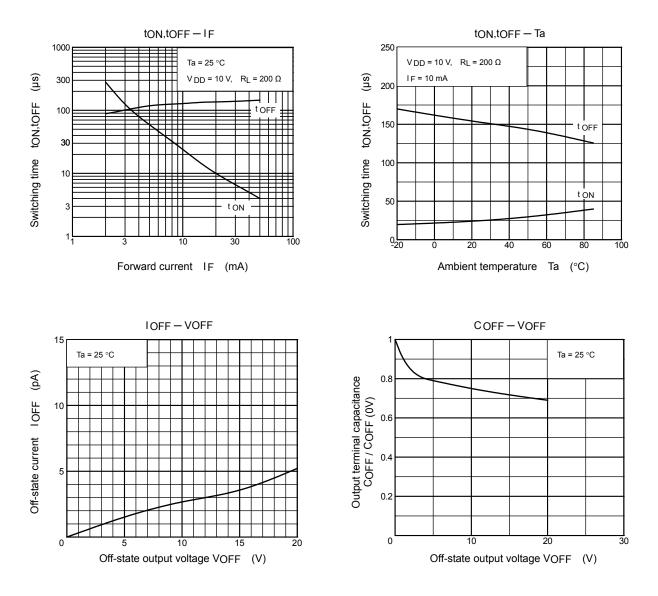




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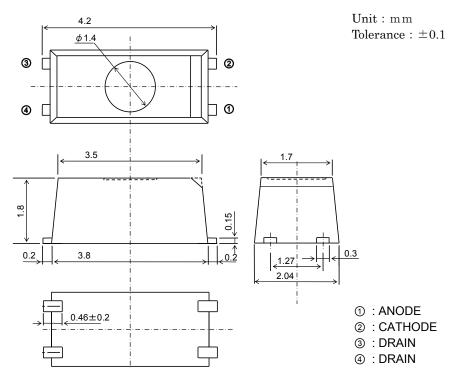


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OUTLINE DRAWING



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